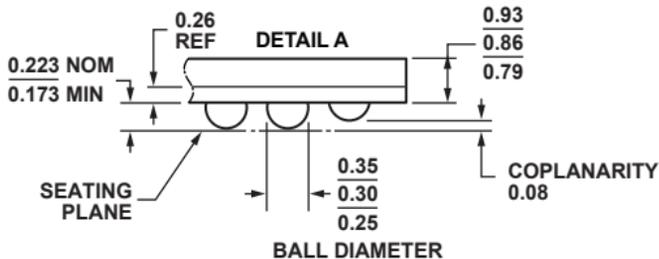
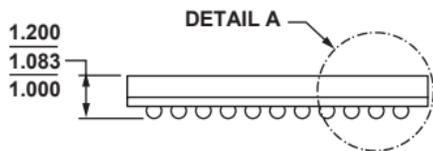
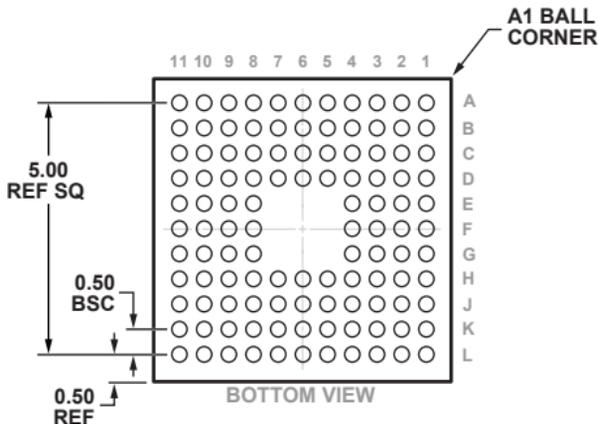
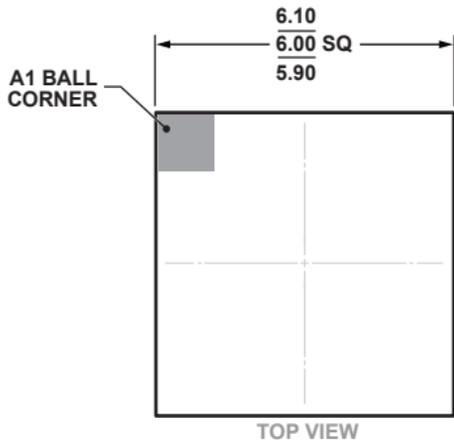


112-Ball Chip Scale Package Ball Grid Array [CSP_BGA]

(BC-112-4)

Dimensions shown in millimeters



**COMPLIANT TO JEDEC STANDARDS MO-195-AC
WITH THE EXCEPTION TO BALL COUNT.**